TOSHIBA Field-Effect Transistor Silicon P-Channel MOS Type

SSM3J35FS

- High-Speed Switching Applications
- Analog Switch Applications
- 1.2 V drive

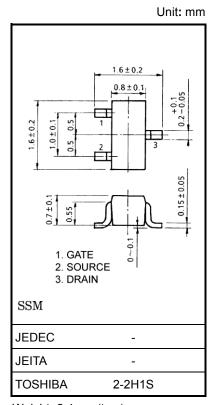
• Low ON-resistance : R_{on} = 44 Ω (max) (@V_{GS} = -1.2 V)

: R_{on} = 22 Ω (max) (@V_{GS} = -1.5 V) : R_{on} = 11 Ω (max) (@V_{GS} = -2.5 V) : R_{on} = 8 Ω (max) (@V_{GS} = -4.0 V)

Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit		
Drain-source voltage	V_{DSS}	-20	V		
Gate-source voltage		V_{GSS}	±10	V	
Drain current	DC	I _D	-100	mA	
	Pulse	I _{DP}	-200	IIIA	
Drain power dissipation		P_{D}	100	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature	T _{stg}	-55 to 150	°C		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the

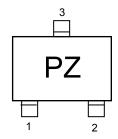


Weight: 2.4 mg (typ.)

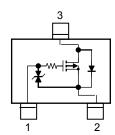
reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Marking



Equivalent Circuit (top view)

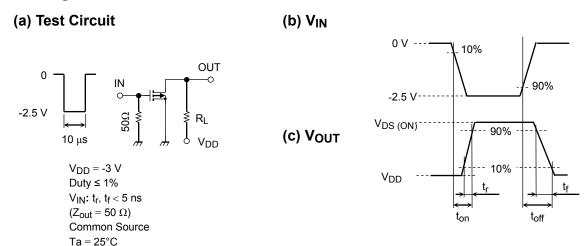


Electrical Characteristics (Ta = 25°C)

Chara	cteristic	Symbol	Test Condition		Min	Тур.	Max	Unit
Gate leakage curr	ent	I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$		_	_	±10	μΑ
Drain-source brea	akdown voltage	V (BR) DSS	I _D = -0.1 mA, V _{GS} = 0 V		-20	_	_	V
Drain cutoff currer	nt	I _{DSS}	V _{DS} = -20 V, V _{GS} = 0 V		_	_	-1	μА
Gate threshold vo	Itage	V _{th}	$V_{DS} = -3 \text{ V}, I_{D} = -1 \text{ mA}$		-0.4	_	-1.0	V
Forward transfer a	admittance	Y _{fs}	$V_{DS} = -3 \text{ V}, I_{D} = -50 \text{ mA}$	(Note 1)	77	_	_	mS
Drain–source ON-resistance		R _{DS} (ON)	$I_D = -50 \text{ mA}, V_{GS} = -4 \text{ V}$	(Note 1)	_	4.3	8	Ω
			$I_D = -50 \text{ mA}, V_{GS} = -2.5 \text{ V}$	(Note 1)	_	5.6	11	
			$I_D = -5 \text{ mA}, V_{GS} = -1.5 \text{ V}$	(Note 1)	_	8.2	22	
			$I_D = -2 \text{ mA}, V_{GS} = -1.2 \text{ V}$	(Note 1)	_	11	44	
Input capacitance Reverse transfer capacitance		C _{iss}	V _{DS} = -3 V, V _{GS} = 0 V, f = 1 MHz		_	12.2	_	pF
		C _{rss}			_	6.5	_	
Output capacitance		Coss			_	10.4	_	
Switching time	Turn-on time	t _{on}	$V_{DD} = -3 \text{ V}, I_D = -50 \text{ mA},$	_	175	-	ns	
	Turn-off time	t _{off}	V _{GS} = 0 to -2.5 V		_	251		_
Drain-source forward voltage		V_{DSF}	I _D = 100 mA, V _{GS} = 0 V	(Note 1)	_	0.83	1.2	٧

Note 1: Pulse test

Switching Time Test Circuit



Usage Considerations

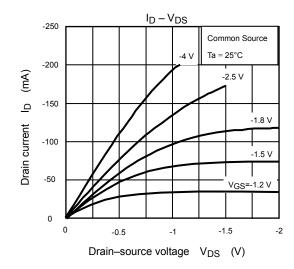
Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to be low (-1 mA for the SSM3J35FS). Then, for normal switching operation, $V_{GS(on)}$ must be higher than V_{th} , and $V_{GS(off)}$ must be lower than V_{th} . This relationship can be expressed as: $V_{GS(off)} < V_{th} < V_{GS(on)}$.

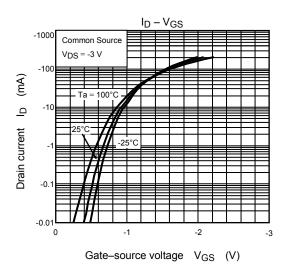
Take this into consideration when using the device.

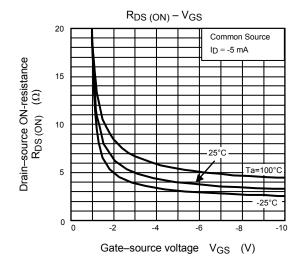
Handling Precaution

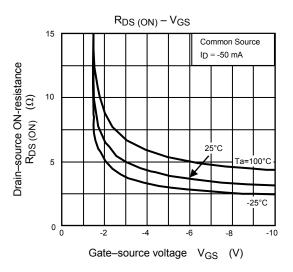
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

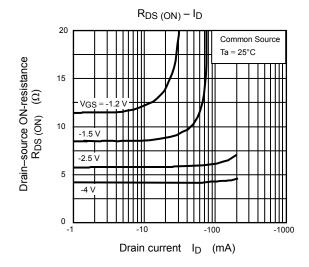
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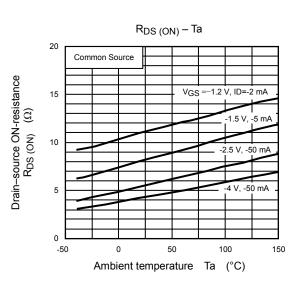




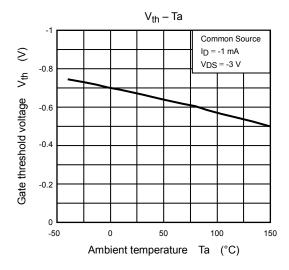


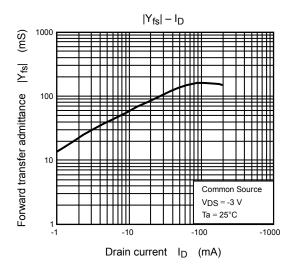


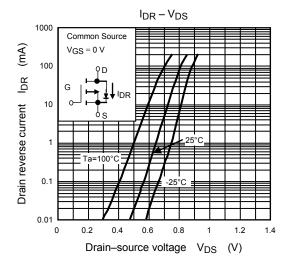


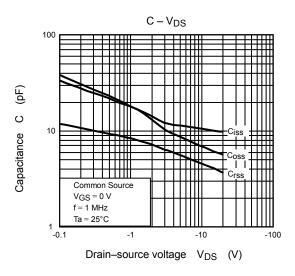


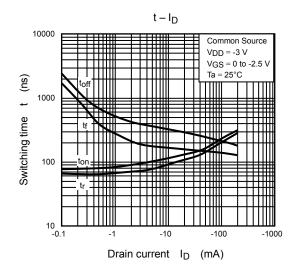
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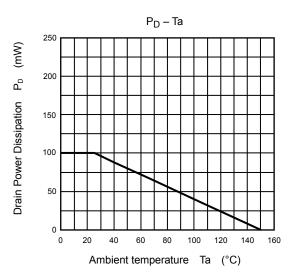












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